Water-based cleaning medium for reflow and wave solder equipment



VIGON® RC 303 was specifically developed to remove all types of baked-on flux residues from reflow and wave solder equipment. It reliably removes recondensed fluxes and emissions from assemblies. As the successor to VIGON® RC 101, VIGON® RC 303 delivers an improved cleaning performance with the same high level of operator safety.

Areas of application: Solder ovens		Additional product information :
Low solid flux residues*	++	
Rosin based flux residues*	++	Technical Information 3: Material compatibility overview.
Water soluble flux residues*	++	Please refer to the material compatibility list (Technical Information 3) before cleaning plastics.
Synthetic fluxes*	++	
Fumigation contamination	++	

⁺⁺ highly recommended, best results

Technical Centers - ① America, ② Europe, ③ Malaysia, ④ North-China, ⑤ South-China Cleaning Process Solutions under Production Floor Conditions











Contact ZESTRON's Process Engineering Team for free-of-charge cleaning trials:

Phone: +49-841-635-26; Email: techsupport@zestron.com

Advantages compared to other cleaning agents:

- Higher cleaning quality and process reliability
 - o Improved cleaning performance
 - The medium does not contain any ingredients which could leave residues on the oven surfaces. This avoids harmful condensation on the assembly surfaces after restarts.
 - Excellent material compatibility with aluminum and epoxy surfaces
- Mild formulation
 - No flash point
 - High operator safety
 - Environmentally friendly
 - No special labeling is required
 - Little odor 0
- More efficient cleaning process to avoid long machine downtimes
 - Short soaking time due to advanced formulation
 - Can be applied directly onto cold or warm surfaces (20 50 °C / 68 122 °F)
 - Also suitable for the pre-cleaning of condensation traps

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- Germany

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⁺ recommended

⁰ possible

⁻ not recommended

^{*} Valid for all standard-, lead-free and lead-based solders











- Spray directly onto cold or warm surfaces (11 bottle). 1.
- 2. Allow cleaning agent to stand for approximately 5 min.
- 3. Wipe surface clean with a cloth or paper towel.
- 4. Air dry

2) Automated cleaning of conveyor fingers in wave solder equipment







- Fill VIGON® RC 303 into the cleaning reservoir of the wave solder equipment 1.
- 2. Automatic brushing device in wave solder oven wipes clean conveyor fingers
- 3. Air dry

Technical Data			
Density	(g/ccm) at 20°C/68°C	1,01	
Surface tension	(mN/m) at 25°C/77°F	31,8	
Boiling range	°C/°F	> 99/ > 210.2	
Flash point	°C/°F	None	
pH-value	10g/l H ₂ O	10.1	
Vapor pressure	(mbar) at 20°C/68°F	Approx. 22	
Cleaning temperature	°C/°F	20 – 50 / 68 – 122	
Solubility in water		Soluble	
Application concentration	Ready-to-use	Pure	
HMIS Rating	Health/Flammability/Reactivity	0 – 0 – 0	

PRODUCT FEATURES



Extensively tested and suitable for cleaning of lead-free solder pastes



Product is free of any critical substances according to SIN & **SVHC** lists



100% compliance with EU guidelines (RoHS 1 & 2, WEEE)

Environmental, health and safety regulations:

- VIGON® RC 303 is water-based and biodegradable.
- VIGON® RC 303 is formulated free of halogenated compounds and is very environmentally friendly and considered a non-hazardous material.
- No special precaution for handling VIGON® RC 303 is required.

Availability/Storage:

- VIGON® RC 303 is available as a ready-to-use solution in 11 spray bottles, 51 or 251 containers and 2001 drums.
- Store VIGON® RC 303 in the original container at a temperature between 5 - 30 °C / 41 - 86 °F.
- The product has a minimum shelf life of 5 years in factory sealed containers.

Alternative product recommendation:

- For dip-tank cleaning of removable oven parts, i.e. condensation traps or solder frames, we recommend ATRON® SP 200, ATRON® SP 300 or ATRON® SP 400.
- This also applies for extremely baked-on residues.

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